

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Dong suk Shin	05/15/2007
Andrew Tae Kim	05/15/2007
Yong kuk Jeong	05/15/2007
RECEIVING PARTY DATA	
Name:	Samsung Electronics Co., Ltd.
Street Address:	416 Maetan-dong, Yeongtong-gu
Internal Address:	Suwon-si
City:	Gyeonggi-do
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11752370
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	5649-2087
NAME OF SUBMITTER:	Candi L. Riggs
Total Attachments: 4 source=Assignment#page1.tif	

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ASSIGNMENT

THIS ASSIGNMENT, made by us, **Dong-suk Shin**, citizen of the Republic of Korea, residing at #108-601 Hyundai Hometown Apt., Seocheon-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea; **Andrew Tae Kim**, citizen of the Republic of Korea, residing at #509-104 Samsung 5-cha Apt., Pungdeokcheon 2-dong, Yongin-si, Gyeonggi-do, Republic of Korea, and **Yong-kuk Jeong**, citizen of the Republic of Korea, residing at #840-701 Byeokjeokgol 8-danji Apt., Yeongtong-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea;

WITNESSETH: That,

WHEREAS, we are the joint inventors of certain new and useful improvements in **SEMICONDUCTOR DEVICES HAVING SELECTIVELY TENSILE STRESSED GATE ELECTRODES AND METHODS OF FABRICATING THE SAME** for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. We hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. 11/752,370, filed 5/23/07) the filing date and application number of said application when known or to file this Assignment concurrently with the application, and

WHEREAS, **Samsung Electronics Co., Ltd.**, a Korean corporation having a principal place of business at 416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer and convey unto the said assignee, its successors and assigns, the entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as

PATENT

ASSIGNMENT – CONTINUED

fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

We hereby request that said Letters Patent be issued in accordance with this assignment.

We further covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and application above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to bind our heirs, legal representatives and assigns, promptly to communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns and other legal representatives.

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 15th day of May, 2007.

DONG SUK SHIN (SEAL)
Dong-suk Shin

Witnessed by:

Date: _____

ASSIGNMENT – CONTINUED

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 15th day
of May, 2007.

Andrew Tae Kim (SEAL)
AndrewTae Kim

Witnessed by:

Date: _____

ASSIGNMENT – CONTINUED

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 15th day
of May, 2007.

Yong-kuk Jeong (SEAL)
Yong-kuk Jeong

Witnessed by:

Date: _____